# SIM and Memory Card Socket Connector

UCS2

Applications | Mobile phone, Computer, Laptop, Medical equipment, Video recorder, Smart Car



## **Specifications**

Current Rating	Contact Resistance	Insulation Resistance	Dielectric Strength	Temperature Range
0.5A/Pin	80mΩ [Max.]	1,000MΩ [Min.]	AC 500V	-40°C ~ 85°C

### Mating Size & Product No.

PINS	PITCH	WIDTH	HEIGHT	LENGHT	CODE
17	1.10	18.27	2.28	14.10	DS110-C17B-C23-A

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### **Product Specification**

	Rated	0.5A/Dip	Operating	-40°C	Storage	-5°C to +40 °C
Potingo	current	0.5A/FIII	temperature range	to +85°C 1	temperature range	(With packing)
Raunys	Rated	Max 10V	Operating	10% to 80%	Storage	
	voltage	AC(RMS) or DC	humidity range	RH 2	humidity range	0370KH

1) Including terminal temperature rise.

2) Storage area is to be free of corrosive gases and dew formation.

Items	Specifications	Conditions
1. Contact resistance	1) Micro-SD : 80mΩ [Max.] 2) Micro-SIM : 80mΩ [Max.] 3) Switch : 160mΩ [Max.]	- Open circuit voltage: 20mV. - Test current: 10mA.
2. Insulation resistance	1,000MΩ [Min.]	- Test voltage: 500V d.c. - Test time: 1 minute ± 5 seconds.
3. Withstanding voltage	No flashover or dielectric breakdown	AC 500V for 1minute
<ol> <li>Card insert &amp; Withdrawal force</li> </ol>	1) Insertion Force : 1.0kgf [Max.] 2) Withdrawal Force: 1.0kgf [Max.]	Insert the tray at a rate of 25±3 mm/min. (actual card used)
5. Terminal Retention force (Vertical direction)	0.12kgf [Min.] / Pin	Apply perpendicular pull out force at the speed rate if 25±3 mm/min.
6. Durability	<ul> <li>No defect such as remarkable abrasion, breakage or crack on the component.</li> <li>MAX. Change from Initial contact resistance 40mΩ MAX.</li> </ul>	Repeat insert and withdrawal Card with 4~10 cycles/min speed 1) micro-SIM : 5,000 cycles 2) micro-SD : 10,000 cycles
7. Vibration	Discontinuity : 1.0 microsec. MAX.	- Vibration frequency range : 10~55Hz - Total amplitude : 1.5mm - Sweep ration : 10-55-10Hz / Approx 1min. - Duration : 2h each (6h in total)
8. Shock resistance	Discontinuity : 1.0 microsec. MAX.	<ul> <li>Acceleration : 50G (490%)</li> <li>Duration : 11ms</li> <li>Number of shocks : 3 both axial directions, 3 times each, 18 times in total</li> <li>Test voltage : 5V d.c.</li> <li>Test current : 1mA d.c.</li> </ul>
9. Humidity	- MAX. Change from Initial contact resistance 40mΩ MAX. - Insulation resistance : 100MΩ Min	- Temperature : 40°C±2°C - Relative humidity : 90% RH to 95% RH - Duration : 96hr
10. Temperature cycle	- MAX. Change from Initial contact resistance 40mΩ MAX. - Insulation resistance : 100MΩ Min	- 55±3(°C) : 30 minutes → - 85±2(°C) : 30 minutes, 5 cycles
11. Solder heat resistance	<ul> <li>No have something wrong of push functions.</li> <li>No have deformation and fall off.</li> <li>No have something wrong outward appearance and structure.</li> </ul>	Reflow condition. (Refer to Reflow)

## Materials / Finish

Part	Materials	Finish	UL Regulation
Base	LCP	Natural	UL94V-0
SIM Cover	Stainless Steel	All Ni plated	-
SD Cover	Stainless Steel	All Ni plated	-
Contact Terminal	Copper Alloy	Au - Ni plated	-
Switch Terminal	Phosphor Bronze	Au - Ni plated	-

#### SOCKET

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#### **Recommended PCB Dimensions** 11.45×0.5×1.31 = SMT SPACE FOR OTHER PARTS7 (10,85×0,25×1,0 = NET SPACE WITH CLEARANCE) 11-15.1 (11-14.1) Switch (0.6) (11.45) (0.6) 22-1.35 (0.5) (2.15) 0.7 <u>.</u> 2 /Sholl(6-6.35) Shell(6-0.7 <u>1.7</u> \$.85 Switch(6.25) Contact(16-6.55) Contact(16-0.50 415 .84 £ NO PATTERN ARÉA 8-0.58 ξ SOCKET SPACES (HATCHING AR ALL PAT (RN 18.1±0.1 (17.8) Pitch 0.88X6=5.28 O I 16.9 1.34 still (0.88) ്ര 13.6 12.09 u ton 10.25 ٢ (C2)82 (C5)88 ¢٦ Ş 2.6 52 3.76 (24-1.35) (0.2) SOCKET OUTLINE PCB OUTLINE-(24 - 7.55)RECOMMENDED PCB LAYOUT [FRONT VIEW] (TOLERANCE:±0.05) (RECOMMEND METAL MASK T=0.10mm) [micro SIM CARD PIN-MAP] [micro SD CARD PIN-MAP] 8P 6P DESCRIPTION PIN NO. DESCRIPTION VCC(Supply v) S1 C1 T1 DAT 2 S2 C2 RST(Reset) T2 CD/DAT 3 S3 C3 CLK(Clock) ТЗ CMD $\mathbb{S}4$ Reserved Τ4 VDD S5 C4 GND Т5 CLK S6 C5 T6 VSS (GND) Vpp(Program) DAT O S7 C6 Vpp(Program) T7 S8 Reserved T8 DAT 1 ---G1-G8 GND S/₩ CARD DETECTOR

### [Circuit diagram for Detection Switch of micro-SD card]

Card insertion condition	Card detect switch	Circutit mSD #6 pin Switch terminal
Without Card	Open	
Card insertion	Close	